	Type	Hits	Search Text	DBs
1	BRS	13	("5924622"|"6333638"|"4744140"|"569050 4"|"5887344"|"5895554"|"5930889"|"6384 360"|"5829988"|"6561836"|"5805427"|"58 10609"|"5987742").PN.	USPAT
2	BRS	13	("5924622"|"6333638"|"4744140"|"569050 4"|"5887344"|"5895554"|"5930889"|"6384 360"|"5829988"|"6561836"|"5805427"|"58 10609"|"5987742").PN.	US-PGPUB; USPAT; USOCR
3	BRS	126	"36217"	US-PGPUB; USPAT; USOCR
4	BRS	6	"re36217"	US-PGPUB; USPAT; USOCR
5	IS&R	4	(("5987742") or ("5690504")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
6	IS&R	5801	(324/758,761,765).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
7	IS&R	1842	(324/758,761,).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
8	IS&R	2	("20030094706").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
9	IS&R	160	(439/41,940).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
10	IS&R	0	("9and@ad<20010830").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB

	Type	Hits	Search Text	DBs
11	BRS	88	S9 and @ad<"20010830"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
12	BRS	11	S9 and @rlad<"20010830"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
13	BRS	88	S11 S12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
14	BRS	0	439/46,64,79,84	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
15	IS&R	1710	(439/46,64,79,84).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
16	BRS	1197	S15 and @ad<"20010830"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
17	BRS	200	S15 and @rlad<"20010830"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
18	BRS	1216	S16 S17	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
19	BRS	1212	S18 not S9	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
20	BRS	171	(chip or die or chips or semiconductor near2 substrate)) and S19	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB

	Type	Hits	Search Text	DBs
21	BRS	110000	(vacuum or suction or pick or lift$4) near15 (chip or chips or die or substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
22	BRS	5292	(pcb or printed adj circuit) and S21	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
23	BRS	4550	(vacuum or suction or pick or lift$4) near15 (chip or chips or die or substrate) near15 (guide or aligment or aligning or pin or pins)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
24	BRS	355	(pcb or printed adj circuit) and S23	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
25	BRS	230	S24 and @ad<"20010830"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
26	BRS	99	S24 and @rlad<"20010830"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
27	BRS	261	S25 S26	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
28	IS&R	6	(("6693674") or ("6384360") or ("4744140")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
29	IS&R	0	("(guidenear2(pinorpins))near15(mechan icalnear2selfnear2lock$3)").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
30	BRS	0	(guide near2 (pin or pins)) near15 (mechanical near2 self near2 lock$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB

	Type	Hits	Search Text	DBs
31	BRS	2	(pin or pins) near15 (mechanical near2 self near2 lock$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
32	BRS	1687	(pin or pins) near15 (self near2 lock$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
33	BRS	21	(guide near2 (pin or pins)) near15 (self near2 lock$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
34	BRS	13	("5924622"|"6333638"|"4744140"|"569050 4"|"5887344"|"5895554"|"5930889"|"6384 360"|"5829988"|"6561836"|"5805427"|"58 10609"|"5987742").PN.	US-PGPUB; USPAT; USOCR
35	IS&R	6015	(324/758,761,765).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
36	IS&R	1885	(324/758,761,).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
37	IS&R	0	("9and@ad<"20010830").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
38	BRS	88	S42 and @ad<"20010830"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
39	BRS	11	S42 and @rlad<"20010830"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
40	BRS	0	439/46,64,79,84	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB

	Type	Hits	Search Text	DBs
41	IS&R	1748	(439/46,64,79,84).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
42	BRS	1199	S48 and @ad<"20010830"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
43	BRS	205	S48 and @rlad<"20010830"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
44	BRS	1222	S49 S50	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
45	BRS	113894	(vacuum or suction or pick or lift$4) near15 (chip or chips or die or substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
46	BRS	5624	(pcb or printed adj circuit) and S54	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
47	BRS	4777	(vacuum or suction or pick or lift$4) near15 (chip or chips or die or substrate) near15 (guide or aligment or aligning or pin or pins)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
48	BRS	380	(pcb or printed adj circuit) and S56	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
49	BRS	232	S57 and @ad<"20010830"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
50	BRS	103	S57 and @rlad<"20010830"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB

	Type	Hits	Search Text	DBs
51	IS&R	0	(" (guidenear2 (pinorpins))near15 (mechan icalnear2selfnear2lock$3)".PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
52	BRS	0	(guide near2 (pin or pins)) near15 (mechanical near2 self near2 lock$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
53	BRS	1715	(pin or pins) near15 (self near2 lock$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
54	BRS	13	("5924622"|"6333638"|"4744140"|"569050 4"|"5887344"|"5895554"|"5930889"|"6384 360"|"5829988"|"6561836"|"5805427"|"58 10609"|"5987742").PN.	USPAT
55	BRS	8	"re36217"	US-PGPUB; USPAT; USOCR
56	IS&R	4	(("5987742") or ("5690504")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
57	IS&R	2	("200300094706").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
58	BRS	88	S44 S45	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
59	IS&R	6	(("6693674") or ("6384360") or ("4744140")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
60	BRS	2	(pin or pins) near15 (mechanical near2 self near2 lock$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB

	Type	Hits	Search Text	DBs
61	BRS	22	(guide near2 (pin or pins)) near15 (self near2 lock$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
62	BRS	132	"36217"	US-PGPUB; USPAT; USOCR
63	IS&R	168	(439/41,940).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
64	BRS	175	(chip or die or chips or (semiconductor near2 substrate)) and S52	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
65	BRS	267	S58 S59	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
66	BRS	1218	S51 not S42	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
67	BRS	22	(guide near2 (pin or pins)) near15 (self near2 lock$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB